

UNISONIC TECHNOLOGIES CO., LTD

3NM120-Q

Preliminary

3.0A, 1200V N-CHANNEL SUPER-JUNCTION MOSFET

DESCRIPTION

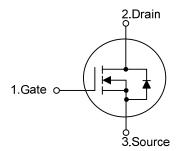
The UTC **3NM120-Q** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

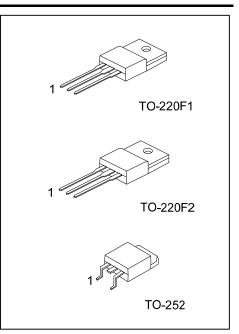
FEATURES

* $R_{DS(ON)} \le 5.6 \Omega @ V_{GS} = 10V, I_D = 1.5A$

* High Switching Speed

SYMBOL





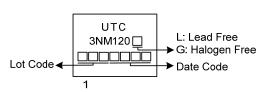
ORDERING INFORMATION

Ordering Number		Pin Assignment			Decking	
Halogen Free	Раскаде	1	2	3	Packing	
3NM120G-TF1-T	TO-220F1	G	D	S	Tube	
3NM120G-TF2-T	TO-220F2	G	D	S	Tube	
3NM120G-TN3-R	TO-252	G	D	S	Tape Reel	
	Halogen Free 3NM120G-TF1-T 3NM120G-TF2-T	Halogen FreePackage3NM120G-TF1-TTO-220F13NM120G-TF2-TTO-220F2	Halogen FreePackage3NM120G-TF1-TTO-220F13NM120G-TF2-TTO-220F2G	Halogen FreePackage123NM120G-TF1-TTO-220F1GD3NM120G-TF2-TTO-220F2GD	Halogen Free Package 1 2 3 3NM120G-TF1-T TO-220F1 G D S 3NM120G-TF2-T TO-220F2 G D S	

Note: Pin Assignment: G: Gate D: Drain S: Source

3NM120 <u>G-TF1-T</u>	
(1)Packing Type	(1) T: Tube, R: Tape Reel
(2)Package Type	(2) TF1: TO-220F1, TF2: TO-220F2, TN3: TO-252
(3)Green Package	(3) G: Halogen Free and Lead Free, L: Lead Free

MARKING



■ ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	1200	V
Gate-Source Voltage		V _{GSS}	±30	V
Continuous Drain Current	Continuous	Ι _D	3	А
	Pulsed	I _{DM}	6	А
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	65	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2	V/ns
Power Dissipation	TO-220F1 TO-220F2	PD	22	W
	TO-252		24	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature.

3. L = 100mH, I_{AS} = 1.14A, V_{DD} = 50V, R_G = 25 Ω Starting T_J = 25°C

4. $I_{SD} \leq 3.0A$, di/dt $\leq 200A/\mu s$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^{\circ}C$

THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient TO-220F1		θ _{JA}	62.5	°C/W
	TO-252		110	°C/W
Junction to Case	TO-220F1 TO-220F2	θ _{JC}	5.68	°C/W
	TO-252		5.2 (Note)	°C/W

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



■ ELECTRICAL CHARACTERISTICS

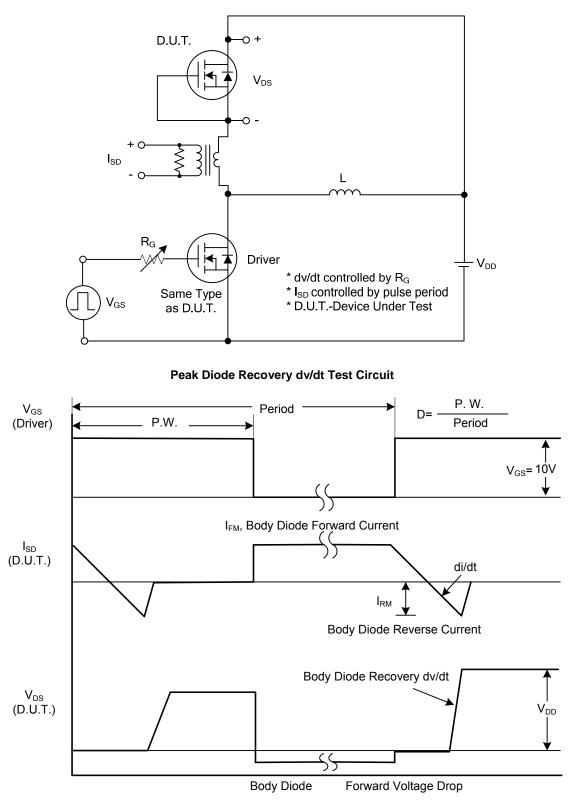
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS	0111202					•
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA, V _{GS} =0V	1200			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =1200V, V _{GS} =0V			10	μA
Forward	- I _{GSS}	V _{GS} =+30V, V _{DS} =0V			+100	nA
Gate-Source Leakage Current Reverse		V _{GS} =-30V, V _{DS} =0V			-100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250µA	2.5		4.5	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =1.5A			5.6	Ω
DYNAMIC PARAMETERS						
Input Capacitance	CISS			290		рF
Output Capacitance	C _{OSS}	V _{GS} =0V, V _{DS} =50V, f=1.0MHz		22		рF
Reverse Transfer Capacitance	C _{RSS}			2.3		рF
SWITCHING PARAMETERS						
Total Gate Charge	Q _G			18		nC
Gate to Source Charge	Q_{GS}	V _{DS} =960V, V _{GS} =10V, I _D =3.0A		6		nC
Gate to Drain Charge	Q_{GD}	(Note 1, 2)		5		nC
Turn-ON Delay Time	t _{D(ON)}			6.4		ns
Rise Time	t _R	V _{DD} =100V, V _{GS} =10V, I _D =3.0A,		17		ns
Turn-OFF Delay Time	t _{D(OFF)}	R _G =25Ω (Note 1, 2)		38		ns
Fall-Time	t⊨			32		ns
SOURCE- DRAIN DIODE RATINGS AND C	HARACTER	ISTICS				
Maximum Body-Diode Continuous Current	ls				3	Α
Maximum Body-Diode Pulsed Current	I _{SM}				6	Α
Drain-Source Diode Forward Voltage	V _{SD}	I _S =3.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time	t _{rr}	I _S =3.0A, V _{GS} =0V,		516		ns
Reverse Recovery Charge	Qrr	dl _F /dt=100A/µs (Note 1)		4.3		μC

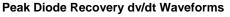
Notes: 1. Pulse Test: Pulse width \leq 1200µs, Duty cycle \leq 2%.

2. Essentially independent of operating temperature.



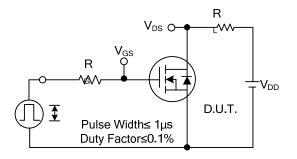
TEST CIRCUITS AND WAVEFORMS



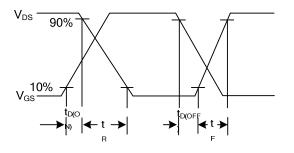




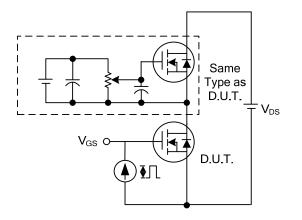
TEST CIRCUITS AND WAVEFORMS



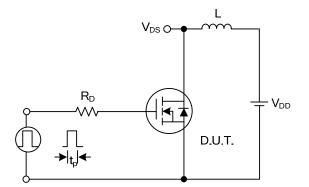
Switching Test Circuit



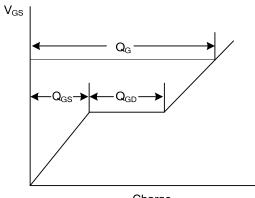
Switching Waveforms



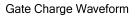
Gate Charge Test Circuit

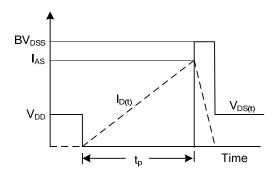


Unclamped Inductive Switching Test Circuit



Charge





Unclamped Inductive Switching Waveforms



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. UTC reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

